

Electronic transport in chemical vapor deposited graphene synthesized on Cu: Quantum Hall effect and weak localization

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We report on electronic properties of graphene synthesized by chemical vapor deposition (CVD) on copper then transferred to SiO₂/Si. Wafer-scale (up to 4 in.) graphene films have been synthesized, consisting dominantly of monolayer graphene as indicated by spectroscopic Raman mapping. Low temperature transport measurements are performed on microdevices fabricated from such CVD graphene, displaying ambipolar field effect (with on/off ratio ~ 5 and carrier mobilities up to ~ 3000 cm²/V s) and “half-integer” quantum Hall effect, a hall-mark of intrinsic electronic properties of monolayer graphene. We also observe weak localization and extract information about phase coherence and scattering of carriers. © 2010 American Institute of Physics.

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Graphene, a single layer of graphite, has attracted tremendous interests as a novel electronic material with many potential applications.^{1,2} The initial experiments revealing graphene’s unique electronic transport properties [such as ambipolar field effect³ and “half-integer” quantum Hall effect (QHE)^{4,5}] were performed with graphene mechanically exfoliated from graphite. While exfoliation typically gives only small (tens of micrometers) graphene flakes and is not a scalable method to produce graphene for practical applications, many other methods are developed to synthesize high quality graphene at large scale. One example is epitaxial growth on SiC.^{6,7} Another example is chemical vapor deposition (CVD) on metals. Metal-based CVD is a decades-old method to grow graphene (see reviews in Refs. 8 and 9). Lately it has received revived interests as a potentially scalable way to produce graphene that can be readily transferred to other substrates for electronic applications.^{10–19} In particular, copper (Cu) has been demonstrated as an exceptional metal substrate allowing CVD growth of large-size single layer graphene with excellent quality and uniformity^{15–17} and promise for applications in transistors,^{15,18} transparent electrodes,^{17,19} and flexible electronics.^{17,19}

In this letter, we demonstrate that CVD graphene grown on Cu possesses intrinsic graphene electronic properties by observing the hall-mark half-integer QHE. We also study the weak localization (WL) to probe carrier scattering and phase coherence. Our results will be important for understanding the electronic properties of CVD-grown graphene on Cu and using such graphene in fundamental research or electronic applications.

The CVD-graphene samples used in this work are synthesized on Cu foils using procedures²⁰ analogous to those in published literature^{15–19} and in our previous work.²¹ The growth pressure is 1 atm (ambient pressure). Following the

synthesis, the Cu is etched and graphene transferred (assisted by PMMA^{11,15}) onto SiO₂/Si. Figures 1(a) and 1(b) show a large (4 × 4 in.²) graphene we synthesized. Figure 1(c) shows representative Raman spectra measured (with a 532 nm laser) at several different spots from the transferred film. The very low disorder-induced “D” band (~ 1350 cm⁻¹) indicates the high quality of the synthesized graphene.²² The large intensity ratio ($I_{2D}/I_G > 2$) of 2D band (~ 2680 cm⁻¹) over “G” band (~ 1580 cm⁻¹) is associated with monolayer graphene.^{15,22} One possible reason for the relatively large variation of I_{2D}/I_G could be the spatially nonuniform adhesion between the transferred graphene and the substrate (SiO₂), as the substrate-interaction can strongly affect the Raman spectrum for monolayer graphene.²³ Figure 1(d)

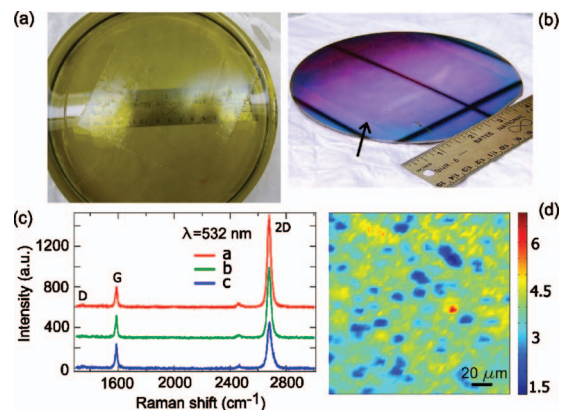


FIG. 1. (Color) Photograph of a 4 × 4 in.² CVD graphene film (a) coated with PMMA and floating on liquid after etching off the Cu substrate and (b) transferred on a Si wafer, with PMMA removed (arrow marks the edge of graphene and thick black lines on the wafer are room ceiling reflections). (c) Representative Raman spectra (c, offset for clarity) measured (with a 532 nm laser) in a CVD graphene film transferred to SiO₂/Si. The 2D band can all be fitted by a single Lorentzian, with center ~ 2680 cm⁻¹ and FWHM ~ 34 cm⁻¹, consistent with previously observed values (Ref. 15). (d) Raman map of I_{2D}/I_G over a $200 \times 200 \mu\text{m}^2$ area, most (99%) of which can be associated with monolayer ($I_{2D}/I_G > 2$).

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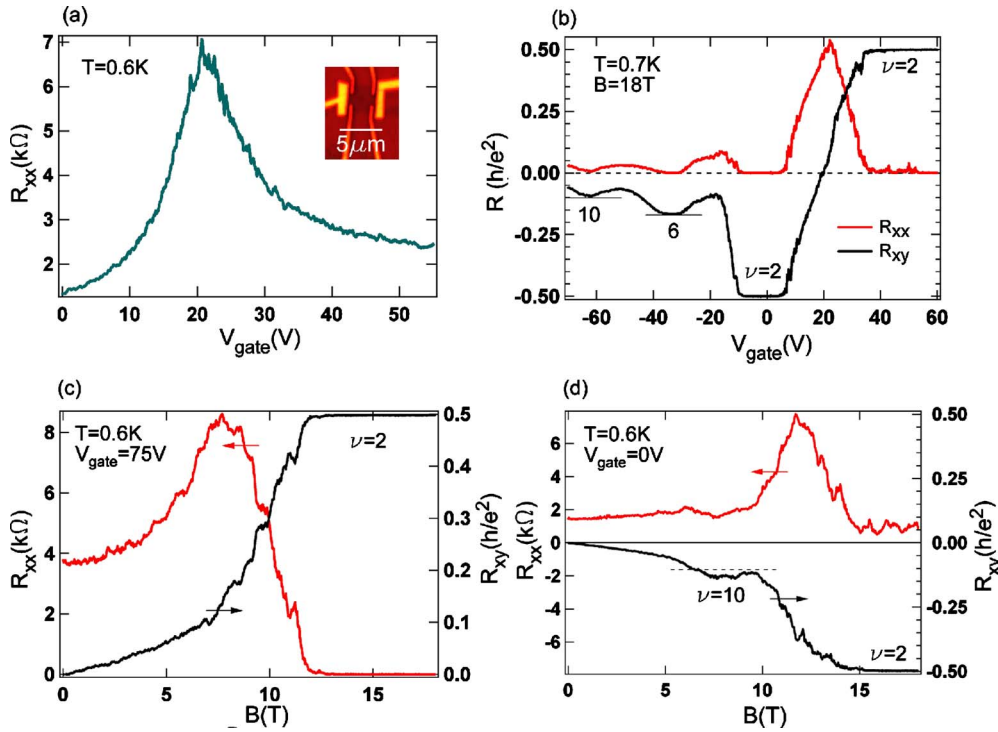


FIG. 2. (Color online) Ambipolar field effect and half integer QHE of CVD graphene. (a) Four-terminal longitudinal resistance (R_{xx}) as a function of gate voltage (V_{gate}) measured in device “A” (optical image shown in the inset). (b) R_{xx} and R_{xy} (Hall resistance) as a function of gate voltage at perpendicular magnetic field $B=18$ T and low temperature ($T=0.7$ K). (c), (d) R_{xx} and R_{xy} as functions of B at $T=0.6$ K for $V_{gate}=75$ V (n-type carriers) and $V_{gate}=0$ V (p-type carriers), respectively. The Landau filling factors (ν) of the observed quantum Hall states are labeled in (b)–(d) and selected QHE plateaus corresponding to $R_{xy}=h/\nu e^2$ are indicated by horizontal lines.

shows a $200 \times 200 \mu\text{m}^2$ Raman map of I_{2D}/I_G , with $\sim 99\%$ of the area having $I_{2D}/I_G > 2$ (and $\sim 90\%$ having $I_{2D}/I_G > 3$), indicating the film is predominantly monolayer graphene.

The transferred graphene is fabricated into quasi-Hall-bar devices using e-beam lithography, O_2 plasma etching and metallization (evaporated Ti/Au contacts). The optical image of a representative device (“A”) is shown in Fig. 2(a) inset. Electrical resistances are measured by low frequency, low current lock-in detection. The carrier density is tuned by a back gate voltage (V_{gate}) applied to the highly doped Si substrate, with the 300 nm SiO_2 as the gate dielectric. Measurements on several such devices yield similar results. Data from two devices (“A” and “B”) are presented below.

Figure 2(a) shows 4-terminal longitudinal resistance (R_{xx}) versus V_{gate} measured in device “A” at low temperature ($T=0.6$ K) and zero magnetic field. We observe the characteristic “ambipolar” field effect,^{3–5,11,12,14,15} with resistance modulation ratio more than five. The charge neutral “Dirac point” (V_{DP} , position of resistance peak) is ~ 20 V for this sample (the positive V_{DP} indicates some extrinsic “residual” hole-doping, common in fabricated graphene devices³). The field effect mobility^{3–5,11,12,14,15} is $\sim 3000 \text{ cm}^2/\text{V s}$ for holes ($V_{gate} < V_{DP}$) and $\sim 1000 \text{ cm}^2/\text{V s}$ for electrons ($V_{gate} > V_{DP}$). Similar field effect is also observed at room temperature, although we can access a larger range of V_{gate} at lower T without gate leakage.

Figure 2(b) shows R_{xx} and R_{xy} (Hall resistance) of device “A” versus V_{gate} at a high magnetic field ($B=18$ T, perpendicular to the sample) and low T (0.7 K). The sign reversal of R_{xy} from $V_{gate} > V_{DP}$ to $V_{gate} < V_{DP}$ is consistent with the ambipolar field effect (change of carrier types). Most remarkably, R_{xy} exhibits clearly quantized plateaus at $h/(2e^2)$ for electrons, $-h/(6e^2)$, and $-h/(10e^2)$ for holes, all accompanied by vanishing R_{xx} , where e is the elementary charge and h is the Plank constant. Such a “half-integer” QHE is an electronic hall-mark of monolayer

graphene.^{4,5} The LL filling factor (ν) for the observed QHE states in Fig. 2(b) is indicated near the corresponding Hall plateaus ($R_{xy}^{-1} = \pm \nu e^2/h$). We have also measured R_{xx} and R_{xy} versus B at fixed V_{gate} showing also half-integer QHE for both electrons in Fig. 2(c) and holes in Fig. 2(d). First observed in exfoliated graphene,^{4,5} half-integer QHE has been observed only very recently in synthesized graphene, including epitaxial graphene grown on SiC,^{24–27} CVD graphene grown on Ni,¹² and now CVD graphene grown on Cu. Observation of such QHE is an important indication that the graphene fabricated by these synthetic (and more scalable) approaches possesses intrinsic graphene properties with electronic quality comparable with graphene exfoliated from graphite.

Figure 3(a) shows $\Delta R_{xx}(B) = R_{xx}(B) - R_{xx}(B=0 \text{ T})$ measured at various T s in device “B”. The low T (e.g., 1.5 K) magnetoresistance displays two following pronounced features that weaken (and eventually disappears) at elevated T : (1) reproducible fluctuations, interpreted as the universal conductance fluctuation (UCF);²⁸ (2) an overall negative magnetoresistance at low B , interpreted as due to WL.²⁸ Both UCF and WL are mesoscopic quantum transport phenomena resulted from the phase coherence of charge carriers. In particular, WL has been used as a powerful tool to probe carrier transport (esp. scattering processes) and disorder in graphene.^{6,29–32} We have fitted [Fig. 3(b) inset] our experimental data by WL theory developed for graphene.³³ Figure 3(b) shows L_ϕ (dephasing length due to inelastic scattering), L_i (elastic intervalley scattering length) and L_* (elastic intravalley scattering lengths) extracted from such fits and plotted versus T . While L_ϕ increases with decreasing T and reaches $\sim 0.3 \mu\text{m}$ at 1.5 K, L_i and L_* are relatively T -insensitive. The fact that all these scattering lengths (L_ϕ , L_i , and L_*) are much smaller than the sample size ($\sim 3 \mu\text{m}$) suggests the dominant scattering source is not the edge, but rather disorder within the sample, such as impurities trapped near graphene or defects in the graphene lattice.^{2,30,31,33} It has

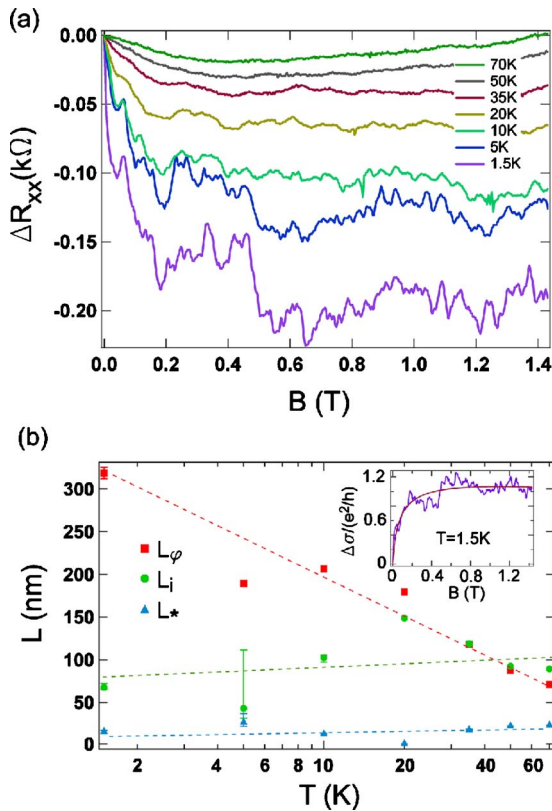


FIG. 3. (Color online) (a) Magnetoresistance $\Delta R_{xx}(B)=R_{xx}(B)-R_{xx}(B=0$ T) measured in device “B” at various temperatures. (b) Extracted characteristic lengths from WL as a function of the temperature. Dashed lines are guides to the eye. Inset shows the magnetoconductivity (calculated from measured data and normalized by e^2/h) $\Delta\sigma_{xx}(B)=\sigma_{xx}(B)-\sigma_{xx}(0$ T) at $T=1.5$ K. Solid line is the fit using the WL theory for graphene (Ref. 33).

been pointed out that inter-valley scattering, which requires atomically-sharp disorder (e.g., point defects),^{30–33} is essential for WL in graphene. The relatively short L_i ($< \sim 150$ nm) observed indicates that an appreciable amount of such disorder is present in our sample. The even shorter L_* ($< L_i$) further suggests the presence of additional source of disorder, such as lattice defects larger than atomic scale (e.g., line defects, dislocations, ripples, etc.).^{2,30}

In summary, we have synthesized wafer-scale graphene with dominant monolayer coverage by ambient pressure CVD on Cu. Our transferable CVD graphene show intrinsic graphene behavior such as half-integer QHE,³⁴ and other excellent electronic properties characterized by the ambipolar field effect, carrier mobility and phase coherence. The large, flexible and transferable graphene films synthesized with a simple and scalable method and possessing excellent uniformity and electronic quality can enable a wide range of applications exploiting the exceptional properties of graphene.

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